

Surge Arrester

Material Data Sheet

Product Class	EC*X (Wire, Tin plated)	
Date	2/7/2024	
IMDS ID if available		
Version	5.01	

Product Part (IMDS: semi component)	Material Class (IMDS: Material)	Material (Classification) VDA 231	Substance	TMPS**) [wt%]	CAS if applicable	typical mass of material [wt-%]	Traces see 1)
Active part	Ceramic	3B	Al2O3	100	1344-28-1	27	
	Metal	1C11	Cu	100	7440-50-8	53	
Brazing ring	Metal	4D	Ag	72	7440-22-4	3	
			Cu	28	7440-50-8		
Plating	Plating	1C8	Sn	100	7440-31-5	1	
Termination	Metal	1C11	Cu	100	7440-50-8	15	
	Metal	1C8	Sn	100	7440-31-5	1	
Sum of total						100	

sizes [mm]	weight range[g]	part name	material numbers
Ø8 X 6.05 X 62	1.4	EC75X	B88069X0180*
		EC90X	B88069X0720*
		EC90XG	B88069X5110*
		EC145X	B88069X5970*
		EC150X	B88069X0880*
		EC230X	B88069X0660*
		EC230XCA	B88069X0950*
		EC230XG	B88069X0850*
		EC230XP	B88069X4340*
		EC230XTA	B88069X0840*
		EC350X	B88069X0810*
		EC350XG	B88069X0920*
		EC425X	B88069X5820*
		EC470X	B88069X5740*
		EC470XG	B88069X5800*
		EC600X	B88069X0780*
		EC600XG	B88069X0790*
Not part of a Product Class			

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Contact	Mohd Faizal Jamaludin	Important remarks: 1) The declaration limit is 0.1% as defined by IEC 62474 (IEC PAS 61906). Traces are product parts, substances etc. that are below a percentage of 0.1 % by weight, if not otherwise regulated. 2) This Material Data Sheet contains typical values of the respective products set forth herein. We expressly point out that all values and statements contained herein are based on our best present knowledge and cannot be regarded as binding statements or binding product specifications, unless otherwise explicitly agreed in writing. TDK ELECTRONICS AG AND ITS AFFILIATES HEREBY EXPRESSLY DISCLAIM ANY REPRESENTATION OR WARRANTY, WHETHER EXPRESS, IMPLIED OR STATUTORY, WITH REGARD TO THE STATEMENTS AND VALUES CONTAINED HEREIN, INCLUDING BUT NOT LIMITED TO ANY REPRESENTATION OR WARRANTY OF MERCHANTABILITY OR SUITABILITY FOR ANY PURPOSE.
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*) others: .(not declarable or prohibited substances acc. GADSL) **) typical mass percentage of substance		

The products set forth herein are "RoHS-compatible". RoHS-compatible means that products are compatible with the requirements according to Art. 4 (substance restrictions) of Directive 2011/65/EU of the European Parliament and of the Council of June 8th, 2011 on the restriction of the use of certain hazardous substances in electrical and electronic equipment.

RoHS - Exemptions for the Product Class / Product according to Annex III: (☒ valid ☐ not valid)

- ☒ **no exemptions;**
- ☐ Exemption 6 (a): Lead as an alloying element in steel for machining purposes and in galvanized steel containing up to 0,35 % lead by weight;
 - ☐ Exemption 6 (b): Lead as an alloying element in aluminium containing up to 0,4 % lead by weight;
 - ☐ Exemption 6 (c): Copper alloy containing up to 4 % lead by weight;
 - ☐ Exemption 7 (a): Lead in high melting temperature type solder (i.e. lead-based alloys containing 85 % by weight or more lead);
 - ☐ Exemption 7 (c)-I: Electrical and electronic components containing lead in a glass or ceramic other than dielectric ceramic in capacitors, e.g. piezoelectronic devices, or in a glass or ceramic matrix compound;
 - ☐ Exemption 7 (c)-II: Lead in dielectric ceramic in capacitors for a rated voltage of 125 V AC or 250 V DC or higher;
 - ☐ Exemption 7 (c)-III: Lead in dielectric ceramic in capacitors for a rated voltage of less than 125 V AC or 250 V DC;
 - ☐ Exemption 15: Lead in solders to complete a viable electrical connection between semiconductor die and carrier within integrated circuit Flip Chip packages;
 - ☐ Other Exemption than above